



<b>Title of Change:</b>	Qualify ON Semiconductor Vietnam (OSV) as an additional Automotive site for Assembly/Test of specified products in DPAK package.
<b>Proposed Changed Material First Ship Date:</b>	16 September 2017 <i>or earlier upon customer request</i>
<b>Current Material Last Order Date:</b>	N/A
<b>Current Material Last Delivery Date:</b>	N/A
<b>Product Category:</b>	<i>Active components – Discrete components</i>
<b>Contact information</b>	Contact your local ON Semiconductor Sales Office or <Phuong.Hoang@onsemi.com>
<b>Samples</b>	Contact your local ON Semiconductor Sales Office to place sample order. Sample requests are to be submitted no later than 45 days after publication of this change notification.
<b>Sample Availability Date:</b>	15 March 2017
<b>PPAP Availability Date:</b>	15 May 2017
<b>Additional Reliability Data</b>	Contact your local ON Semiconductor Sales Office or <Cheanching.sim@onsemi.com>.
<b>Type of Notification</b>	This is a Final Product/Process Change Notification (FPCN) sent to customers. This FPCN is being issued 6 months prior to implementation because this change provides an alternate source to an ON manufacturing facility utilizing the same BOM. ON Semiconductor will consider this proposed change and it's conditions acceptable, unless an inquiry is made in writing within 30 days of delivery of this notice. To do so, contact <PCN.Support@onsemi.com>.
<b>Change Category:</b>	<b>Type of Change</b>
Process – Assembly	Move of all or part of assembly to a different location/site/subcontractor.
Process – Assembly	Change of product marking.
Test Flow	Move of all or part of electrical wafer test and/or final test to a different location/site/subcontractor.
Equipment	Production from a new equipment/tool which uses the same basic technology (replacement equipment or extension of existing equipment pool) without change of process.
<b>Description and Purpose:</b>	
<p>This Final Notification announces the plan to qualify ON Semiconductor Vietnam (OSV) as an additional Assembly and Test site for operations of Automotive discrete DPAK packaged products.</p> <p>Upon the expiration of this FPCN, new OSV part numbers will be available to allow specified products to be sourced from either the Seremban or Vietnam locations using the same Bill of Material.</p> <p>ON Semiconductor Vietnam (OSV) is qualified site for DPAK Standard discrete packaged products and is ISO TS16949 certified.</p> <p>Products sourced from OSV have been qualified to Automotive requirements and continue remain as Pb-free, Halide free and RoHS compliant.</p>	
<b>Reason / Motivation for Change:</b>	<ul style="list-style-type: none"> <li>• Change benefits for customer: <ul style="list-style-type: none"> <li>○ Unconstrained Automotive Sourcing</li> <li>○ Seamless dual source Mfg alternatives, ensuring capacity availability</li> <li>○ Instantaneous capacity available for growth; Short lead times; Lines down aversion</li> </ul> </li> <li>• Risk for late release for customer: Limited capacity.</li> </ul>



<b>Anticipated impact on fit, form, function, reliability, product safety or manufacturability</b>	The device has been qualified and validated based on the same Product Specification. The device has successfully passed the qualification tests. Potential impacts can be identified, but due to testing performed by ON Semiconductor in relation to the PCN, associated risks are verified and excluded.  No anticipated impacts.
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<b>Sites Affected:</b>			
<input type="checkbox"/> All site(s)	<input type="checkbox"/> not applicable	<input checked="" type="checkbox"/> ON Semiconductor site(s) : ON Seremban, Malaysia ON Dong Nai Province, Vietnam	<input type="checkbox"/> External Foundry/Subcon site(s)

<b>Marking of Parts/ Traceability of Change:</b>	Product from ON Semiconductor Vietnam (OSV) will be marked with site code "VN" prior to the date code while the Seremban device does not have site code marking.
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**Reliability Data Summary:**

**QV DEVICE NAME:** MJD340T4G (Bipolar)

**PACKAGE:** DPAK

Test	Specification	Condition	Interval	Result
HTRB	JESD22-A108	Ta = 150 °C, bias = 80% of rated V	1008 hrs	0/84
HTSL	JESD22-A103	Ta = 150 °C	1008 hrs	0/84
IOL	MIL-STD-750 (M1037) AEC-Q101	Ta=+25°C, deltaTj=100°C max, Ton = Toff = 2min	15000 cyc	0/84
TC	JESD22-A104	Temp = -65°C to +150°C	1000 cyc	0/84
AC	JESD22-A102	121°C, 100% RH, 15psig, unbiased	96 hrs	0/84
H3TRB	JESD22-A101	Temp = 85°C, RH=85%, bias = 100V max	1008 hrs	0/84
PC	J-STD-020 JESD-A113	MSL 1 @ 260 °C		0/336
RSH	JESD22- B106	Ta = 265°C, 10 sec		0/30
SD	JSTD002	Ta = 245°C, 10 sec		0/15

**QV DEVICE NAME:** MJD350T4G (Bipolar)

**PACKAGE:** DPAK

Test	Specification	Condition	Interval	Result
HTRB	JESD22-A108	Ta = 150 °C, bias = 80% of rated V	1008 hrs	0/84
HTSL	JESD22-A103	Ta = 150 °C	1008 hrs	0/84
IOL	MIL-STD-750 (M1037) AEC-Q101	Ta=+25°C, deltaTj=100°C max, Ton = Toff = 2min	15000 cyc	0/84
TC	JESD22-A104	Temp = -65°C to +150°C	1000 cyc	0/84
AC	JESD22-A102	121°C, 100% RH, 15psig, unbiased	96 hrs	0/84
H3TRB	JESD22-A101	Temp = 85°C, RH=85%, bias = 100V max	1008 hrs	0/84
PC	J-STD-020 JESD-A113	MSL 1 @ 260 °C		0/336
RSH	JESD22- B106	Ta = 265°C, 10 sec		0/30
SD	JSTD002	Ta = 245°C, 10 sec		0/15



**QV DEVICE NAME:** NTD6414ANT4G (Mosfet)

**PACKAGE:** DPAK

Test	Specification	Condition	Interval	Result
HTRB	JESD22-A108	Ta = 175 °C, bias = 80% of rated V	1008 hrs	0/84
HTGB	JESD22-A108	Ta = 175 °C, 100% max rated Vgss	1008 hrs	0/84
HTSL	JESD22-A103	Ta = 175 °C	1008 hrs	0/84
IOL	MIL-STD-750 (M1037) AEC-Q101	Ta=+25°C, deltaTj=100°C max, Ton = Toff = 2min	15000 cyc	0/84
TC	JESD22-A104	Temp = -55°C to +150°C	1000 cyc	0/84
AC	JESD22-A102	121°C, 100% RH, 15psig, unbiased	96 hrs	0/84
H3TRB	JESD22-A101	Temp = 85°C, RH=85%, bias = 80% of rated V	1008 hrs	0/84
PC	J-STD-020 JESD-A113	MSL 1 @ 260 °C		0/336
RSH	JESD22- B106	Ta = 265°C, 10 sec		0/30
SD	JSTD002	Ta = 245°C, 10 sec		0/15

**QV DEVICE NAME:** NTD110N02RT4G (Mosfet)

**PACKAGE:** DPAK

Test	Specification	Condition	Interval	Result
HTRB	JESD22-A108	Ta = 175 °C, bias = 80% of rated V	1008 hrs	0/84
HTGB	JESD22-A108	Ta = 175 °C, 100% max rated Vgss	1008 hrs	0/84
HTSL	JESD22-A103	Ta = 175 °C	1008 hrs	0/84
IOL	MIL-STD-750 (M1037) AEC-Q101	Ta=+25°C, deltaTj=100°C max, Ton = Toff = 2min	15000 cyc	0/84
TC	JESD22-A104	Temp = -55°C to +150°C	1000 cyc	0/84
AC	JESD22-A102	121°C, 100% RH, 15psig, unbiased	96 hrs	0/84
H3TRB	JESD22-A101	Temp = 85°C, RH=85%, bias = 80% of rated V	1008 hrs	0/84
PC	J-STD-020 JESD-A113	MSL 1 @ 260 °C		0/336
RSH	JESD22- B106	Ta = 265°C, 10 sec		0/30
SD	JSTD002	Ta = 245°C, 10 sec		0/15



**QV DEVICE NAME:** MURHD560T4G (Ultrafast Rectifier)

**PACKAGE:** DPAK

Test	Specification	Condition	Interval	Result
HTRB	JESD22-A108	Ta = 150 °C, Tj(est) = 175 °C, bias = 80% of rated V	1008 hrs	0/252
HTSL	JESD22-A103	Ta = 175 °C	1008 hrs	0/252
IOL	MIL-STD-750 (M1037) AEC-Q101	Ta=+25°C, deltaTj=100°C max, Ton = Toff = 2min	15000 cyc	0/252
TC	JESD22-A104	Temp = -65°C to +150°C	1000 cyc	0/252
AC	JESD22-A102	121°C, 100% RH, 15psig, unbiased	96 hrs	0/252
H3TRB	JESD22-A101	Temp = 85°C, RH=85%, bias = 100V max	1008 hrs	0/252
PC	J-STD-020 JESD-A113	MSL 1 @ 260 °C		0/1008
RSH	JESD22- B106	Ta = 265°C, 10 sec		0/90
SD	JSTD002	Ta = 245°C, 10 sec		0/45

**QV DEVICE NAME:** MBRD5H100T4G (Schottky Rectifier)

**PACKAGE:** DPAK

Test	Specification	Condition	Interval	Result
HTRB	JESD22-A108	Tj = 90 °C, bias = 80% of rated V	1008 hrs	0/84
HTSL	JESD22-A103	Ta = 175 °C	1008 hrs	0/84
IOL	MIL-STD-750 (M1037) AEC-Q101	Ta=+25 °C, deltaTj=100°C max, Ton = Toff = 2min	15000 cyc	0/84
TC	JESD22-A104	Temp = -65°C to +150 °C	1000 cyc	0/84
AC	JESD22-A102	121°C, 100% RH, 15psig, unbiased	96 hrs	0/84
H3TRB	JESD22-A101	Temp = 85 °C, RH=85%, bias = 80% of rated V	1008 hrs	0/84
PC	J-STD-020 JESD-A113	MSL 1 @ 260 °C		0/336
RSH	JESD22- B106	Ta = 265 °C, 10 sec		0/30
SD	JSTD002	Ta = 245 °C, 10 sec		0/15

**NOTE: AEC-1pager is attached.**

To access file attachments on pdf copy of PCN, please be guided by the steps below:

1. Download pdf copy of the PCN to your computer
2. Open the downloaded pdf copy of the PCN
3. Click on the paper clip icon available on the menu provided in the left/bottom portion of the screen to reveal the Attachment field
4. Then click on the attached file/s

**Electrical Characteristic Summary:**

Electrical characteristics are not impacted.



**List of Affected Standard Parts:**

Current SBN Part Number	New OSV Part Number	Qualification Vehicle
NRVBD650CTG	NRVBD650CTG-VF01	MBRD5H100T4G
NRVBD660CTRLG	NRVBD660CTRLG-VF01	
SBRD8320T4G	SBRD8320T4G-VF01	
SBRD8330G	SBRD8330G-VF01	
SBRD8330T4G	SBRD8330T4G-VF01	
SBRD8340G	SBRD8340G-VF01	
SBRD8350G	SBRD8350G-VF01	
SBRD8350T4G	SBRD8350T4G-VF01	
SBRD8340T4G	SBRD8340T4G-VF01	
NRVBD640CTG	NRVBD640CTG-VF01	
NRVBD650CTT4G	NRVBD650CTT4G-VF01	
NRVBD660CTG	NRVBD660CTG-VF01	
SBR835LT4G	SBR835LT4G-VF01	
SBRD81035CTLG	SBRD81035CTLG-VF01	
SBRD8320G	SBRD8320G-VF01	
SBRD8360G	SBRD8360G-VF01	
SBRD8360RLG	SBRD8360RLG-VF01	
SBRD8835LG	SBRD8835LG-VF01	
SSRD8620CTRG	SSRD8620CTRG-VF01	
NRVUD320W1T4G	NRVUD320W1T4G-VF01	
NRVUD340T4G	NRVUD340T4G-VF01	
SUR620CTT4G	SUR620CTT4G-VF01	
SURHD8560T4G	SURHD8560T4G-VF01	
SURD8530T4G	SURD8530T4G-VF01	
NRVUD550PFT4G	NRVUD550PFT4G-VF01	
NRVUD620CTG	NRVUD620CTG-VF01	NTD110N02RT4G
STD110N02RT4G	STD110N02RT4G-VF01	NTD6414ANT4G
NVD3055-094T4G	NVD3055-094T4G-VF01	
NVD3055L170T4G	NVD3055L170T4G-VF01	
NVD6414ANT4G	NVD6414ANT4G-VF01	
NVD6415ANT4G	NVD6415ANT4G-VF01	
NVD6416ANLT4G-001	NVD6416ANLT4G-001-VF01	
NVD6416ANT4G	NVD6416ANT4G-VF01	
NVD6495NLT4G	NVD6495NLT4G-VF01	MJD340T4G
NJVMJD42CT4G	NJVMJD42CT4G-VF01	MJD350T4G
SJD127T4G	SJD127T4G-VF01	

**List of Affected Customer Specific Parts:**

NOTE: Please be informed that parts impacted by this PDN/PCN are Special/Customer specific parts, thus MPN & CPN info will be available to affected customers only by clicking the "Custom PCN for Selected Company Button" in the Document Analysis page of PCMS/PCN Alert.